-5 V Differential ECL to TTL Translator

Description

The MC10ELT/100ELT25 is a differential ECL to TTL translator. Because ECL levels are used, a +5 V, -5.2 V (or -4.5 V) and ground are required. The small outline 8-lead package and the single gate of the ELT25 makes it ideal for those applications where space, performance and low power are at a premium.

The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a $0.01~\mu F$ capacitor and limit current sourcing or sinking to 0.5~mA. When not used, V_{BB} should be left open.

The 100 Series contains temperature compensation.

Features

- 2.6 ns Typical Propagation Delay
- 100 MHz F_{MAX} CLK
- 24 mA TTL Outputs
- Flow Through Pinouts
- Operating Range: $V_{CC} = 4.5 \text{ V}$ to 5.5 V with GND = 0 V; $V_{EE} = -4.2 \text{ V}$ to -5.7 V with GND = 0 V
- Internal Input 50 K Ω Pulldown Resistors
- Q Output will default HIGH with inputs open or < 1.3 V
- Pb-Free Packages are Available



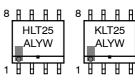
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http://onsemi.com

MARKING DIAGRAMS*



SOIC-8 D SUFFIX CASE 751





TSSOP-8 DT SUFFIX CASE 948R











DFN8 MN SUFFIX CASE 506AA

1

H = MC10 A = Assembly Location
K = MC100 L = Wafer Lot
5F = MC10 Y = Year
2U = MC100 W = Work Week
M = Date Code ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

^{*}For additional marking information, refer to Application Note AND8002/D.

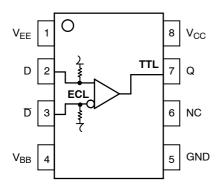


Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

Table 1. PIN DESCRIPTION

Pin	Function
D, \overline{D}	ECL Differential Inputs
Q	TTL Output
V _{BB}	Reference Voltage Output
V _{CC}	Positive Supply
V _{EE}	Negative Supply
GND	Ground
NC	No Connect
EP	Exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply or leave floating open.

Table 2. ATTRIBUTES

Characteris	Value				
Internal Input Pulldown Resistor	Internal Input Pulldown Resistor				
Internal Input Pullup Resistor		N	/A		
ESD Protection		kV 00 V			
Moisture Sensitivity, Indefinite Time	Pb Pkg	Pb-Free Pkg			
	SOIC-8 TSSOP-8 DFN8				
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0	@ 0.125 in		
Transistor Count	38 De	evices			
Meets or exceeds JEDEC Spec EIA	/JESD78 IC Latchup Test				

^{1.} For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{CC}	Positive Power Supply	GND = 0 V	V _{EE} = -5.0 V	7	V
V _{EE}	Negative Power Supply	GND = 0 V	V _{CC} = +5.0 V	-8	V
V _{IN}	Input Voltage	GND = 0 V		0 to V _{EE}	V
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-8 SOIC-8	190 130	°C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-8	41 to 44	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	TSSOP-8 TSSOP-8	185 140	°C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-8	41 to 44 ± 5%	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	DFN8 DFN8	129 84	°C/W °C/W
T _{sol}	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. 10ELT SERIES NECL INPUT DC CHARACTERISTICS V_{CC} = 5.0 V; V_{EE} = -5.0 V; GND = 0 V (Note 2)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
V _{IH}	Input HIGH Voltage (Single-Ended) (Note 3)	-1230		-890	-1130		-810	-1060		-720	mV
V _{IL}	Input LOW Voltage (Single-Ended) (Note 3)	-1950		-1500	-1950		-1480	-1950		-1445	mV
V _{BB}	Output Voltage Reference	-1.43		-1.30	-1.35		-1.25	-1.31		-1.19	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Notes 3 and 4)	-2.8		0.0	-2.8		0.0	-2.8		0.0	٧
I _{IH}	Input HIGH Current			255			175			175	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.3			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 2. Input parameters vary 1:1 with GND. V_{EE} can vary +0.06 V to -0.5 V.
- 3. TTL output $R_L = 500 \Omega$ to GND
- 4. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with GND.

Table 5. 100ELT SERIES NECL INPUT DC CHARACTERISTICS V_{CC} = 5.0 V; V_{EE} = -5.0 V; GND = 0 V (Note 5)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
V _{IH}	Input HIGH Voltage (Single-Ended) (Note 6)	-1165		-880	-1165		-880	-1165		-880	mV
V _{IL}	Input LOW Voltage (Single-Ended) (Note 6)	-1810		-1475	-1810		-1475	-1810		-1475	mV
V _{BB}	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Notes 6 and 7)	-2.8		0.0	-2.8		0.0	-2.8		0.0	٧
I _{IH}	Input HIGH Current			255			175			175	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 5. Input parameters vary 1:1 with GND. V_{EE} can vary +0.8 V to -0.5 V.
- 6. TTL output R_L = 500 Ω to GND
- 7. V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with GND.

Table 6. TTL OUTPUT DC CHARACTERISTICS V_{CC} = 4.5 V to 5.5 V; T_A = -40°C to +85°C

Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = −3.0 mA	2.4			V
V _{OL}	Output LOW Voltage	I _{OL} = 24 mA			0.5	V
I _{CCH}	Power Supply Current			11	16	mA
I _{CCL}	Power Supply Current			13	18	mA
I _{EE}	Negative Power Supply Current			15	21	mA
Ios	Output Short Circuit Current		-150		-60	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 7. AC CHARACTERISTICS V_{CC} = 5.0 V; V_{EE} = -5.0 V; GND= 0 V (Note 8 and Note 9)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Toggle Frequency					100					MHz
t _{PLH}	Propagation Delay @ 1.5 V	1.7		3.6	1.7		3.6	1.7		3.6	ns
t _{PHL}	Propagation Delay @ 1.5 V	2.6		4.1	2.6		4.1	2.6		4.1	ns
t _{JITTER}	Random Clock Jitter (RMS)					35					ps
t _r t _f	Output Rise/Fall Times QTTL 10% – 90%					1.9 2.3					ns
V_{PP}	Input Swing (Note 10)	200		1000	200		1000	200		1000	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 8. V_{CC} can vary \pm 0.25 V.
- V_{EE} can vary +0.06 V to -0.5 V for 10ELT; V_{EE} can vary +0.8 V to -0.5 V for 100ELT. 9. R_L = 500 Ω to GND and C_L = 20 pF to GND. Refer to Figure 2.
- 10. V_{PP}(min) is the minimum input swing for which AC parameters are guaranteed. The device has a DC gain of 140.

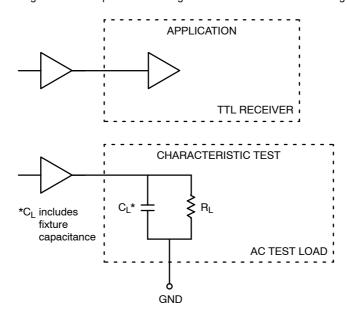


Figure 2. TTL Output Loading Used for Device Evaluation

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10ELT25D	SOIC-8	98 Units / Rail
MC10ELT25DG	SOIC-8 (Pb-Free)	98 Units / Rail
MC10ELT25DR2	SOIC-8	2500 / Tape & Reel
MC10ELT25DR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel
MC10ELT25DT	TSSOP-8	100 Units / Rail
MC10ELT25DTG	TSSOP-8 (Pb-Free)	100 Units / Rail
MC10ELT25DTR2	TSSOP-8	2500 / Tape & Reel
MC10ELT25DTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel
MC10ELT25MNR4	DFN8	1000 / Tape & Reel
MC10ELT25MNR4G	DFN8 (Pb-Free)	1000 / Tape & Reel
MC100ELT25D	SOIC-8	98 Units / Rail
MC100ELT25DG	SOIC-8 (Pb-Free)	98 Units / Rail
MC100ELT25DR2	SOIC-8	2500 / Tape & Reel
MC100ELT25DR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel
MC100ELT25DT	TSSOP-8	100 Units / Rail
MC100ELT25DTG	TSSOP-8 (Pb-Free)	100 Units / Rail
MC100ELT25DTR2	TSSOP-8	2500 / Tape & Reel
MC100ELT25DTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel
MC100ELT25MNR4	DFN8	1000 / Tape & Reel
MC100ELT25MNR4G	DFN8 (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques
 AN1406/D - Designing with PECL (ECL at +5.0 V)
 AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit
 AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide
AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

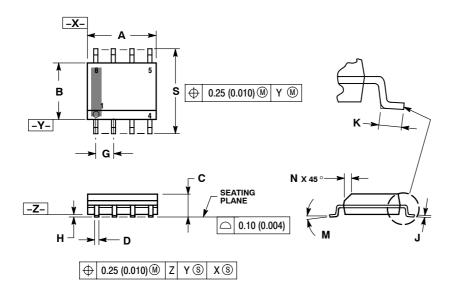
AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

SOIC-8 NB CASE 751-07 **ISSUE AH**



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

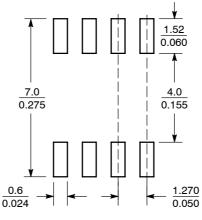
 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.

 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
 PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.127 (0.005) TOTAL
 IN EXCESS OF THE D DIMENSION AT
 MAXIMUM MATERIAL CONDITION.
 6. 751–01 THRU 751–06 ARE OBSOLETE. NEW
 STANDARD IS 751, 07
- STANDARD IS 751-07.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
C	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	7 BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
М	0 °	8 °	0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

SOLDERING FOOTPRINT*

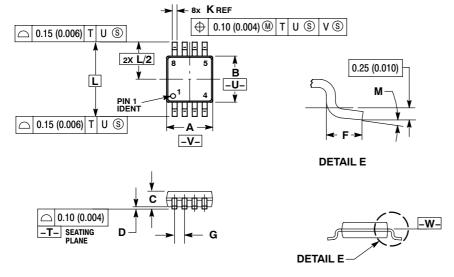


 $\left(\frac{\text{mm}}{\text{inches}}\right)$ SCALE 6:1

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
- 2. CONTINGUING DIMENSION. MILLIDIETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.
 PROTRUSIONS OR GATE BURRS. MOLD FLASH
 OR GATE BURRS SHALL NOT EXCEED 0.15
- (0.006) PER SIDE.

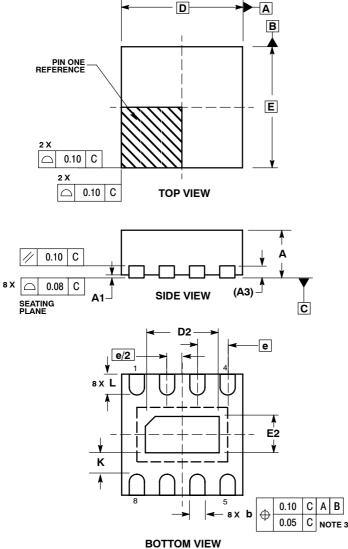
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

 5. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
 6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.114	0.122
В	2.90	3.10	0.114	0.122
С	0.80	1.10	0.031	0.043
D	0.05	0.15	0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65	BSC	0.026	BSC
K	0.25	0.40	0.010	0.016
L	4.90	BSC	0.193	BSC
M	0°	6°	0°	6°

PACKAGE DIMENSIONS

DFN8 CASE 506AA-01 ISSUE D



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	MAX				
Α	0.80	1.00				
A1	0.00	0.05				
АЗ	0.20	REF				
b	0.20	0.30				
D	2.00	BSC				
D2	1.10	1.30				
Е	2.00	BSC				
E2	0.70	0.90				
е	0.50 BSC					
Κ	0.20					
L	0.25	0.35				

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